



## EMVCo Security Evaluation

### Development / Production Site Attestation Letter

Please accept this document as confirmation of the EMVCo Security Evaluation Process.

**Attestation Reference Number:** SALN0036

**Company:** Goldpac Limited

**Address:** Goldpac Tech Park  
4088 Jinfeng Rd, Fengshan  
Guangdong Province  
Zhuhai 519070 People's Republic of China

**Site Name:** Goldpac Tech Park

**Site Address:** 4088 Jinfeng Rd, Fengshan  
Guangdong Province  
Zhuhai, 519070 People's Republic of China

**Type:** Production

**Date Issued:** 31 Jul 2025

**SAR Reference:** ESVGOL001R1\_SAR\_M0.pdf

**Security Laboratory:** Applus+

**Certification Reference Documents:**

- EMVCo Security Evaluation Process, v5.4, July 2024
- EMV Security Guidelines - Development and Production Site Audit Guidelines, Version 1.1. May 2015

**Authorized by:** Alan Mushing  
Security Evaluation Working Group Chair  
EMVCo, LLC

**Date:** 26 Sep 2025

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The EMVCo Security Evaluation Process is intended to provide with valuable and practical information relating to the general security performance characteristics and the suitability of use for smart card related products and IC chip-based tokens. The EMVCo Security Evaluation Process is designed to ensure a robust security foundation for these products at the product family and component level. The full terms and conditions upon which EMVCo Attestation Letters are issued by EMVCo are contained in the EMVCo Security Evaluation Process Document and the EMVCo Security Evaluation Certification Contract. The Product Provider, when distributing this EMVCo Attestation Letter, shall deliver it in its entirety.